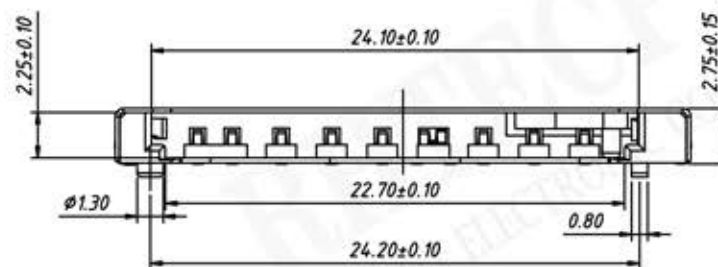
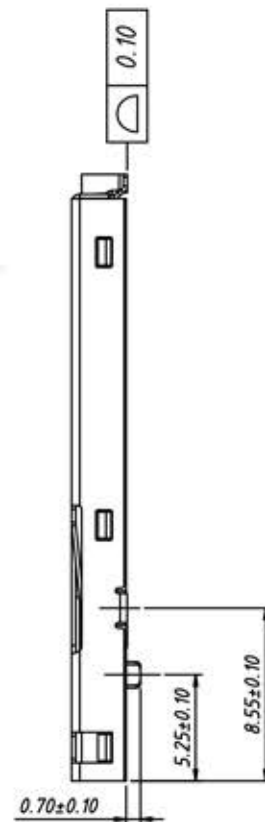
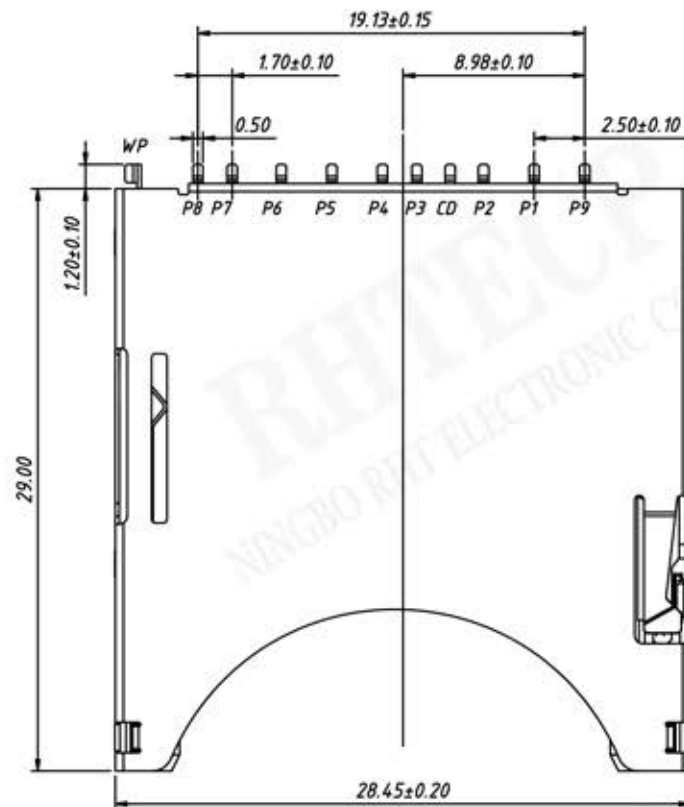
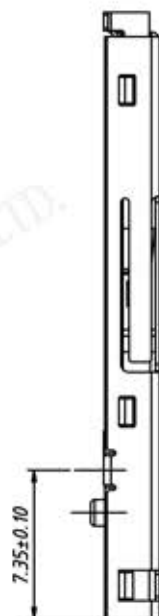


PIN NO.		SD	MMC
P1	MMC-DAT;SD-DAT3	1 P	1 P
P2	MMC-CMD;SD-CMD	2 P	2 P
P3	MMC-VSS1;SD-VSS1	3 P	3 P
P4	MMC-VDD;SD-VDD	4 P	4 P
P5	MMC-CLK;SD-CLK	5 P	5 P
P6	MMC-VSS2;SD-VSS2	6 P	6 P
P7	MMC-ADT;SD-DAT0	7 P	7 P
P8	SD-DAT1	8 P	
P9	SD-DAT2	9 P	



**Material:**

Insulator: High Temperature Thermoplastic, UL94V-0.

Contact: Copper Alloys. Plated 50u" Ni Overall Plated Au Selective Contact Area, Plated 100u" Sn Over Ni On Solder Area.

Shell: Plated 50u" Ni Overall.

**Electrical:**

Voltage Rating: 125V AC/DC

Current Rating: 0.5mA AC/DC Max.

Ambient Temperature Range: -20°C ~ +60°C

Storage Temperature Range: -40°C ~ +70°C

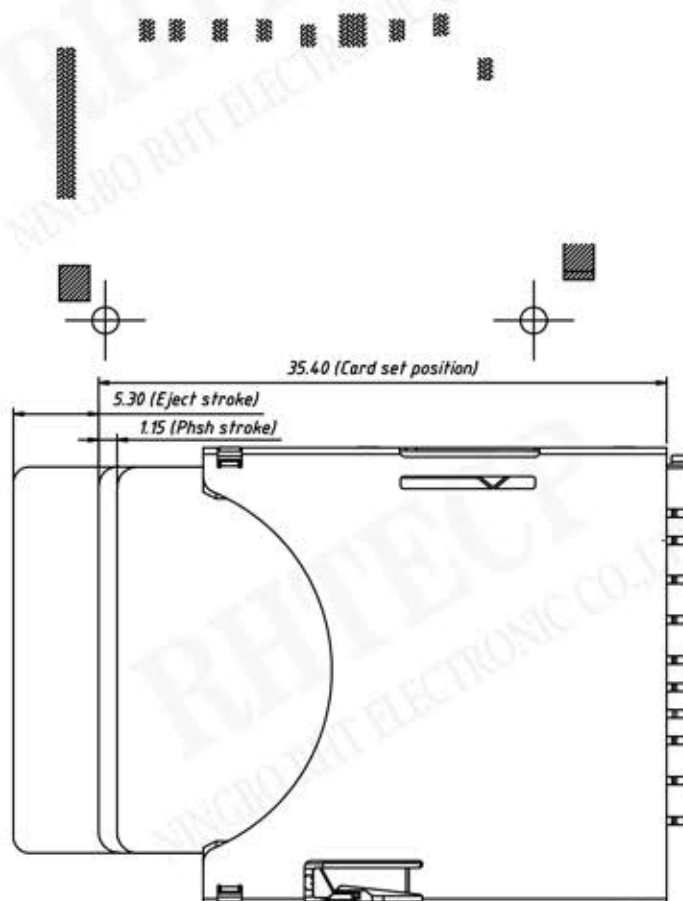
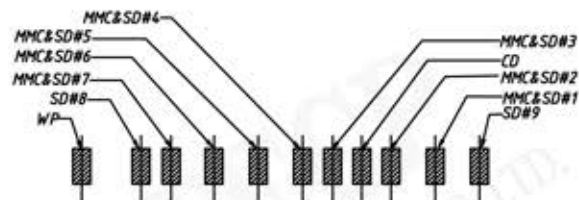
Ambient Humidity Range: 95% R.H. Max.

Contact Resistance: 100mΩ Max.

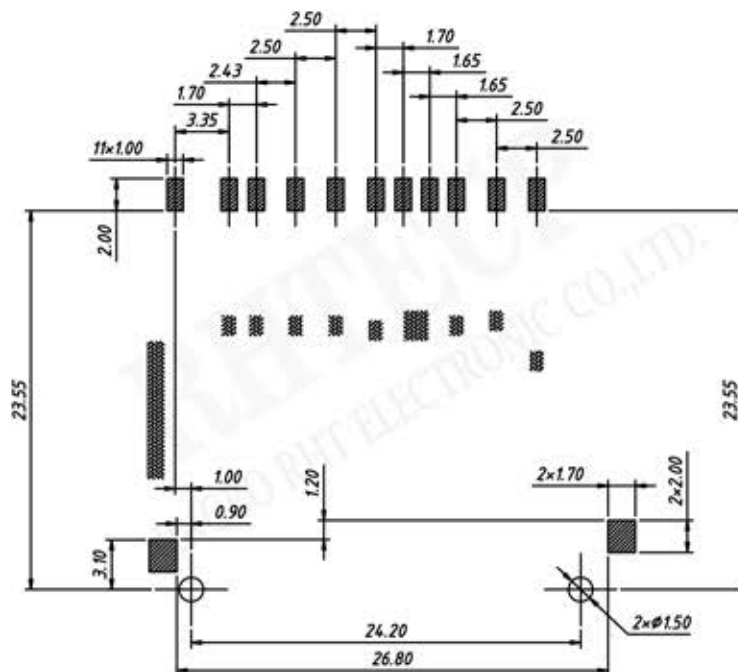
Insulation Resistance: 1000MΩ Min./500V DC

Mating Cycles: 10000 Insertions.

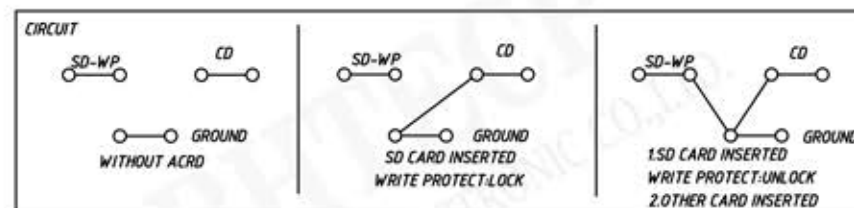
PIN ASSIGNMENT:

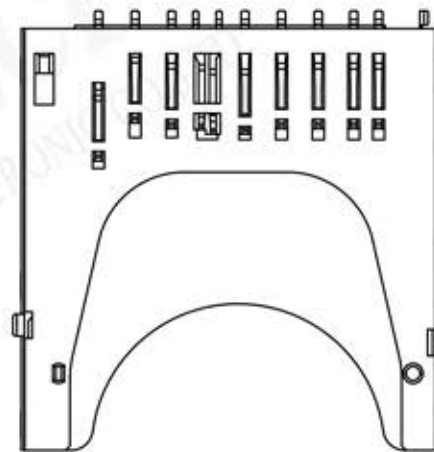
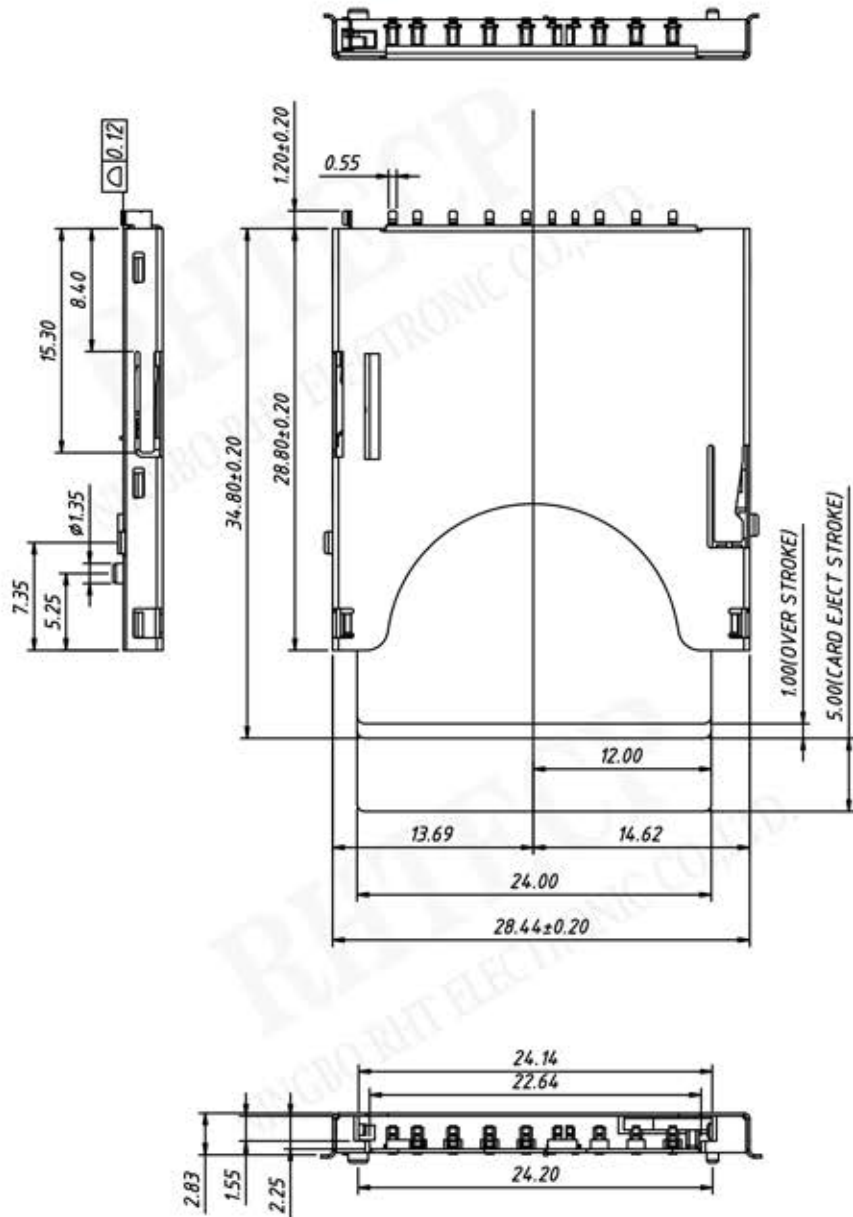


View of inserted card



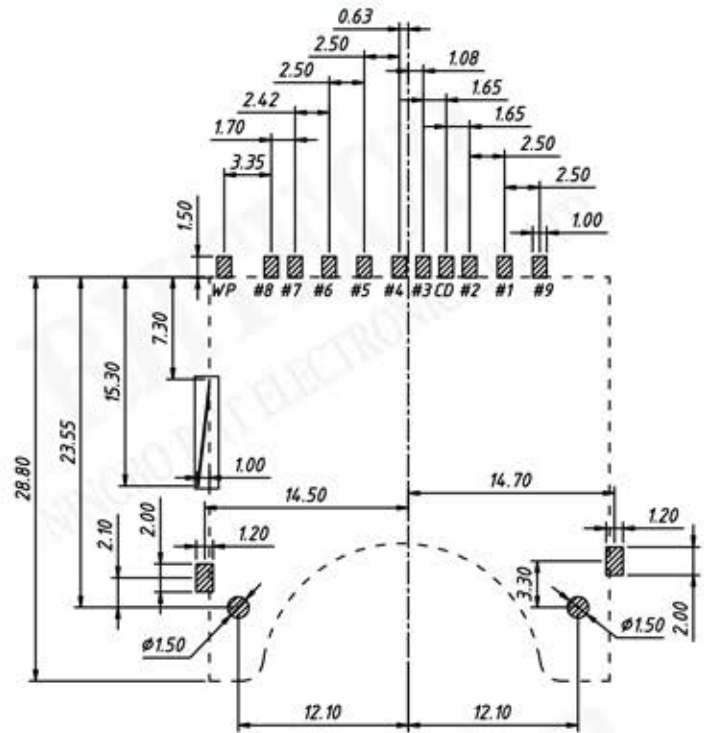
Welding area  
Prohibited layout area



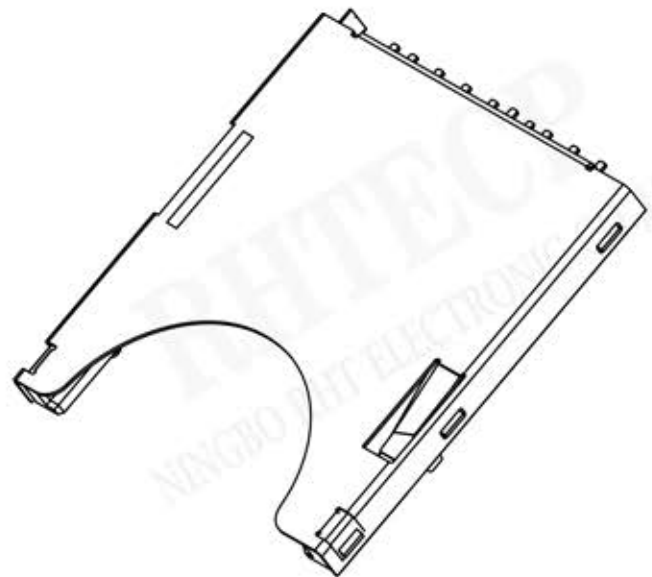


**Material:**  
 Housing: High Temperature Plastic, UL 94 V-0, Black.  
 Contact: Copper Alloys.  
 Shell: Stainless.

**Plating:**  
 Contact area: Gold Flash.  
 Solder area: Matte Tin Plated.  
 Under Plate: Nickel.  
 Shell: Nickel Plated Over All.  
 Solder area: Gold Flash.



PCB LAYOUT



SD CARD PIN DESIGN

PIN NO	NAME	TYPE	DESCRIPTION
#1	CD/DAT3	I/O/PP	CARD DETECT DATE LINE(BIT3)
#2	CMD	PP	COMMAND RESPONSE
#3	VSS1	S	SUPPLY VOLTAGE GROUND
#4	VDD	S	SUPPLY VOLTAGE
#5	CLK	I	CLOCK
#6	VSS2	S	SUPPLY VOLTAGE GROUND
#7	DAT0	I/O/PP	DATE LINE(BIT0)
#8	DAT1	I/O/PP	DATE LINE(BIT1)
#9	DAT2	I/O/PP	DATE LINE(BIT2)

